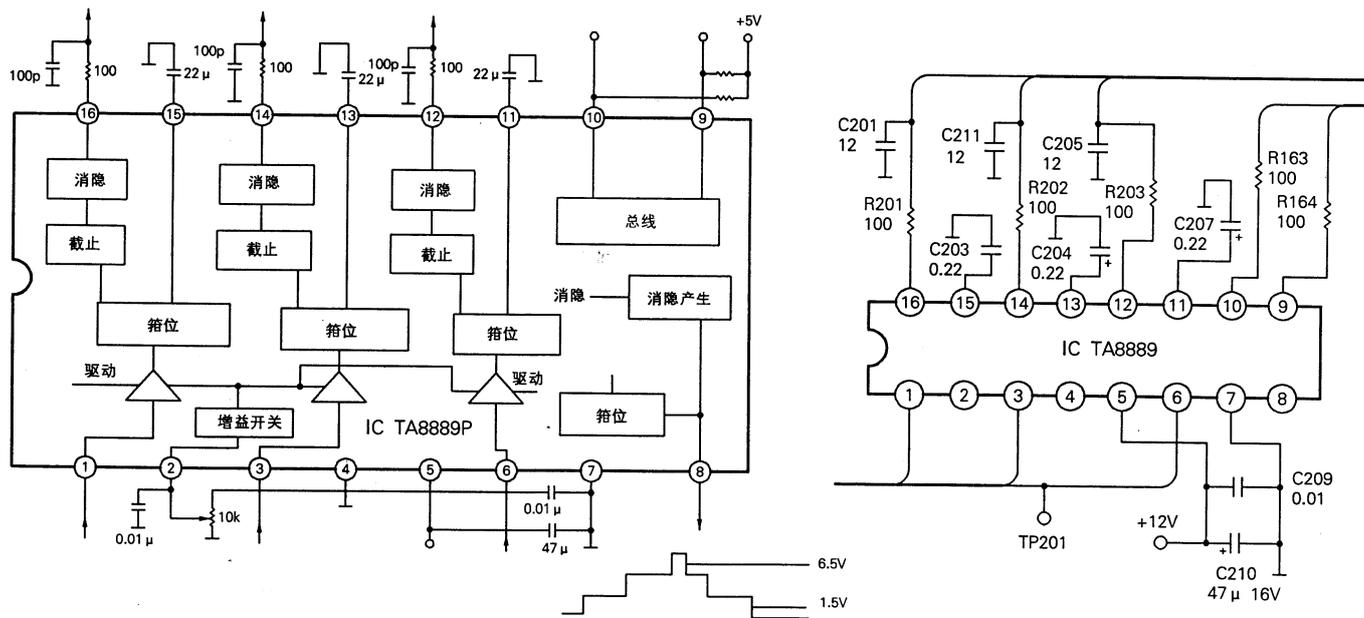


相似替换型号: TA8889 TA8889AP



集成电路内部方框图及外部电路图

引脚序号	英文缩写	集成电路引脚功能	备注	电阻参数 (kΩ)		直流电压参数 (V)		外形参考图
				正笔接地	负笔接地	电源通	有信号	
①	R IN	红基色信号输入		12.3	8		2.7	
②	V _{DD}	电源+12V		1.5	1.5		12	
③	G IN	绿基色信号输入		12.6	8		2.6	
④	GND	接地		0	0		0	
⑤	V _{CC}	电源+12V		0.53	0.53		12	
⑥	B IN	蓝基色信号输入		13	8		2.7	
⑦	GND	接地		0	0		0	
⑧	SAND IN	沙堡脉冲输入		11.3	8		1.3	
⑨	SCL	时钟线		8	6.4		4.9	
⑩	SDA	数据线		7.8	6.4		4.9	
⑪	B CLAMP	蓝电平箝位信号		12.5	9		5.7	
⑫	B OUT	蓝基色信号输出		12	8.9		3	
⑬	G CLAMP	绿电平箝位信号		12.5	9		5.8	
⑭	G OUT	绿基色信号输出		12	8.8		2.9	
⑮	R CLAMP	红电平箝位信号		12.5	9		5.6	
⑯	R OUT	红基色信号输出		12.1	8.4		2.9	

集成电路引脚功能参数



TOSHIBA BIPOLAR LINEAR INTEGRATED CIRCUIT SILICON MONOLITHIC

TA8889AP

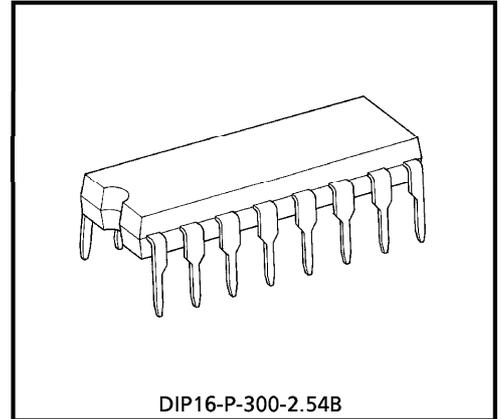
RGB CUT OFF DRIVE CONTROL IC

The TA8889AP is 16pin DIP package IC which has RGB Cut off/Drive control circuit.

The feature of TA8889AP is controlled via I²C bus.

FEATURES

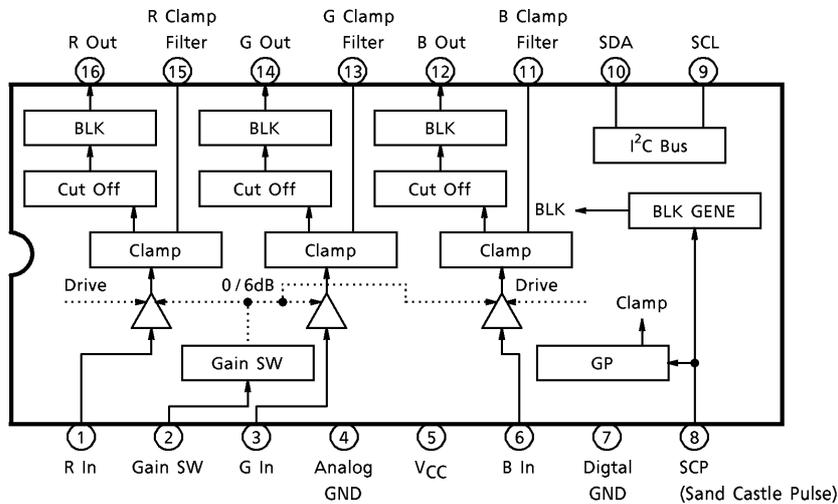
- 3 independents cut off control for 3 primary color.
- Independent drive control for blue and green color.
- 0dB / 6dB gain SW
- I²C bus interface circuit



DIP16-P-300-2.54B

Weight : 1.11g (Typ.)

BLOCK DIAGRAM



TERMINAL FUNCTION

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
1 3 6	R In G In B In	These are primary color input terminals. The signal which pedestal DC level is 2V should be inputted.	
2	Gain SW	This is the switch terminal for gain 0dB/6dB and blanking pulse. Please refer gain SW mode table for detail.	
4	Analog GND	This is the GND terminal for analog circuit.	—
5	VCC	This is common VCC terminal for analog and digital circuit. The coupling capacitor should be connected between this terminal and digital GND.	—
7	Digital GND	This is GND terminal for I ² L circuit. The coupling capacitor should be connected between this terminal and digital GND.	—
8	S.C.P.	This is S.C.P. input terminal. The threshold level of clamp pulse is 6.5V and more (typ.), that of blanking pulse is 1.5V and less (typ.).	
9	SCL	This is SCL terminal for I ² C bus. Because its is week for surge impulse, connect external devices for protection against surge if necessary.	

PIN No.	PIN NAME	FUNCTION	INTERFACE CIRCUIT
10	SDA	This is SDA terminal for I ² C bus. Because its is week for surge impulse, connect external devices for protection against surge if necessary.	
15 13 11	R Clamp Filter G Clamp Filter B Clamp Filter	This is the clamp filter terminal for R /G /B signal which is the signal after cut off and drive circuit.	
16 14 12	R Out G Out B Out	This is the R /G /B signal output terminal. We recommend its connects L.P.F. for removing high frequency noise.	

TERMINAL 2 (GAIN SW) OUTPUT MODE TABLE

(V_{CC} = 12V, T_a = ±3°C)

TERMINAL VOLTAGE	GAIN	BLANKING
V _{CC} (9.7V~V _{CC})	6dB	Available
7.5V (6.7V~8.3V)		Not available
4.5V (3.7V~5.3V)	0dB	Not available
GND (GND~2.3V)		Available

I²C BUS CONTROL MAP

- Slave address : 10011000 (98H)
- Sub address

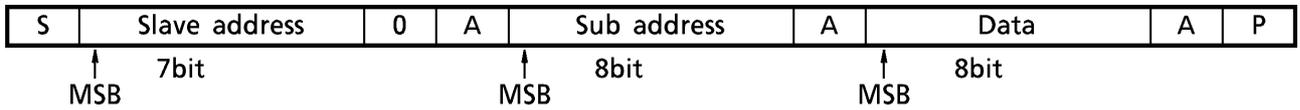
SUB ADDRESS		7	6	5	4	3	2	1	0	PRESET	
00	(I)	Red color cut off control (10bit)								LSB	00000000 (00H)
01	(II)	x	x	x	x	x	x	MSB ↑		00000000 (00H)	
02	(I)	Green color cut off control (10bit)								LSB	00000000 (00H)
03	(II)	x	x	x	x	x	x	MSB ↑		00000000 (00H)	
04	(I)	Blue color cut off control (10bit)								LSB	00000000 (00H)
05	(II)	x	x	x	x	x	x	MSB ↑		00000000 (00H)	
06	(III)	MSB	Red color drive control (8bit)						LSB	00000000 (00H)	
07	(III)	MSB	Blue color drive control (8bit)						LSB	00000000 (00H)	

(Note) x bit : don't care

I²C BUS CONTROLLED FORMAT SUMMARY

Bus controlled format of TA8889AP is based on I²C bus control format of Philips.

Data transfer format

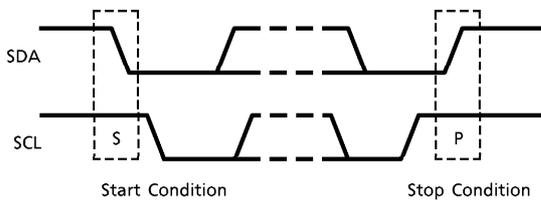


S : Start Condition

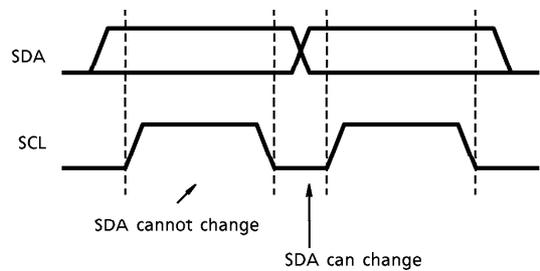
P : Stop Condition

A : Acknowledge

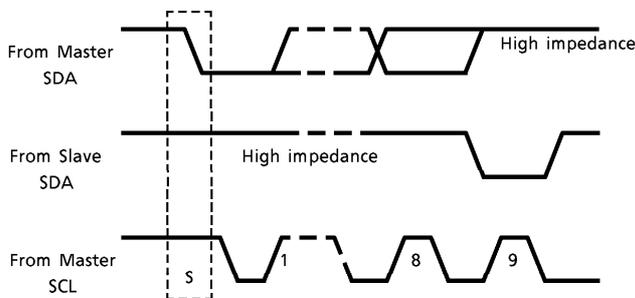
(1) Start and stop condition



(2) Bit transfer



(3) Acknowledge



(4) Slave address

A6	A5	A4	A3	A2	A1	A0	R/W
1	0	0	1	1	0	0	0

Purchase of TOSHIBA I²C components conveys a license under the Philips I²C Patent Rights to use these components in an I²C system, provided that the system conforms to the I²C Standard Specification as defined by Philips.

MAXIMUM RATINGS (Ta = 25°C ± 3°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Power Supply Voltage	V _{CC}	15	V
Power Dissipation	P _D (Note 1)	1.4	W
Input Signal Voltage	e _{in}	7	V _{p-p}
Terminal Voltage	V _{in} (Note 2)	GND - 0.3 ~ V _{CC} + 0.3	V
Operating Temperature	T _{opr}	- 20 ~ 65	°C
Storage Temperature	T _{stg}	- 65 ~ 150	°C

(Note 1) When using the device at above Ta = 25°C, decrease the power dissipation by 11.2mW for each increase of 1°C.

(Note 2) Rating of pin 9 and 10 is GND - 0.3V ~ 5.5V.

RECOMMENDED SUPPLY VOLTAGE

PIN No.	PIN NAME	MIN.	TYP.	MAX.	UNIT
5	V _{CC}	10.8	12.0	13.2	V

ELECTRICAL CHARACTERISTICS

DC characteristics (Unless otherwise specified, V_{CC} = 12V, Ta = 25 ± 3°C)

CHARACTERISTIC	SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Power Supply Current	I _{CC}	—	Pin 1, 3, 6-DC 2V input Pin 8-S.C.P. input Pin 2-6dB MODE Sub address (I) = 00H (II) = 02H (III) = 80H	46	56	70	mA
Terminal Voltage	V ₁₁	—		5.0	6.0	7.0	V
	V ₁₂			2.8	3.0	3.2	
	V ₁₃			5.0	6.0	7.0	
	V ₁₄			2.8	3.0	3.2	
	V ₁₅			5.0	6.0	7.0	
	V ₁₆			2.8	3.0	3.2	

AC characteristics (Unless otherwise specified, $V_{CC} = 12V$, $T_a = 25 \pm 3^\circ C$)

Drive circuit

CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Frequency Characteristic		f_c	—	(Note 1)	10	20	30	MHz	
Cross-talk		C_V	—	(Note 2)	45	50	—	dB	
6dB Mode Gain	Max.	G_{6MA}	—	(Note 3)	SA (III) : FFH	9.0	10.0	11.5	dB
	Typ.	G_{6TY}			SA (III) : 80H	3.5	5.5	7.5	
	Min.	G_{6MI}			SA (III) : 00H	1.0	2.0	3.0	
0dB Mode Gain	Max.	G_{0MA}	—	(Note 4)	SA (III) : FFH	3.0	4.0	5.5	dB
	Typ.	G_{0TY}			SA (III) : 80H	1.5	-0.5	-2.5	
	Min.	G_{0MI}			SA (III) : 00H	-3.0	-4.0	-5.5	
Gain Control Range	Max.	G_{VMA}	—	(Max. Gain / Min. Gain) - (Typ. Gain) Both 0 / 6dB mode	3.0	5.0	6.0	dB	
	Min.	G_{VMI}			3.0	3.5	4.0		
Input Dynamic Range	Max. DC	G_{JDA}	—	(Note 5)	6.5	7.0	—	V	
	Min. DC	G_{JDI}			—	1.0	1.5		
Output Dynamic Range	Max. DC	V_{ODA}	—	(Note 6)	10.0	10.5	—	V	
	Min. DC	V_{ODI}			—	1.0	1.5		

Cut off circuit

CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
Min. Control Range		V_{LSB}	—	(Note 7)	—	3.0	5.0	mV	
DC Voltage Control Range	Max.	V_{CVI}	—	(Note 8)	(I) (II) : FF03H	4.25	4.5	—	V
	Min.	V_{CVA}			(I) (II) : 0000H	—	1.6	1.8	
	Range	V_{CV}			(Max) - (Min)	2.5	2.9	—	
Center Off-set		V_{COF}	—	(Note 9)	(I) (II) : 0002H	0.8	1.0	1.2	V
Max. Input DC Level		V_{IMA}	—	(Note 10)	(I) (II) : 0000H	—	4.5	5.0	V
Min. Input DC Level		V_{IMI}			(I) (II) : FF03H	0.3	0.5	—	
Max. Output DC Level		V_{OMA}			(I) (II) : FF03H	—	5.4	6.0	
Min. Output DC Level		V_{OMI}			(I) (II) : 0000H	1.2	1.5	—	
Non Linear Point Value	SA : 7F00	V_{AC1}	—	(Note 11)	—	—	3.0	mV	
	SA : FF00	V_{AC2}			—	—	3.0		
	SA : FF01	V_{AC3}			—	—	3.0		

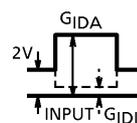
Threshold circuit

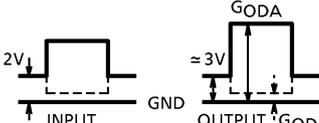
CHARACTERISTIC		SYMBOL	TEST CIR-CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT	
S.C.P. Threshold	GATE P	V_{GP}	—	—	6.2	6.5	6.8	V	
	Hori. P	V_{HP}			1.2	1.5	1.8		
	Vert. P	V_{VP}			1.2	1.5	1.8		
Blanking Level		V_{BLNK}	V_{BL}	—	(Note 12)	0.20	0.25	0.30	V

TEST CONDITION

Drive circuit

NOTE No.	ITEM		TERMINAL 2 MODE	SUB ADDRESS & DATA			MEASUREMENT METHOD
				(I)	(II)	(III)	
1	Frequency Characteristic		6dB (7.5V)	00H	02H	FFH	(1) Pin 1 (Pin 3, 6) : DC 4V. (2) Adjust the input voltage at Pin 15 (Pin 13, 11) to make Output voltage = 5.5V. (3) Pin 1 (Pin 3, 6) : 1MHz, 300mV _{p-p} , DC 4V, sine wave. Measure the output level (vout). (4) Measure the input level to make Output level = (vout - 3dB)
2	Cross-talk		0dB (GND)	↑	↑	80H	(1) The same as Note 1. (2) The same as Note 1. (3) Pin 1 (Pin 3, 6) : 5MHz, DC 4V, sine wave. (4) Measure the cross-talk.
3	6dB Mode Gain	Max.	6dB (7.5V)	↑	↑	FFH	(1) Pin 8 : S.C.P. or Gate pulse. (2) Pin 1 (Pin 6) : signal = (pedestal level = 2V, amplitude 3V). (3) Measure the output level. Calculate the $20\log$ (output level / input level).
		Typ.				80H	
		Min.				00H	
4	0dB Mode Gain	Max.	0dB (GND)	↑	↑	FFH	(1) The same as Note 3. (2) Pin 1 (Pin 6) : signal = (pedestal level = 2V, amplitude 1.5V). (3) The same as Note 3.
		Typ.				80H	
		Min.				00H	
5	Input Dynamic Range	Max. DC	↑	↑	↑	00H	(1) The same as Note 3. (2) Pin 1 (Pin 6) : signal = (under Fig.) (3) Make input signal larger to output signal saturation level. Measure the input level. →G _{IDA} (4) Make input signal smaller to output signal saturation level. Measure the input level. →G _{IDI}
		Min. DC					

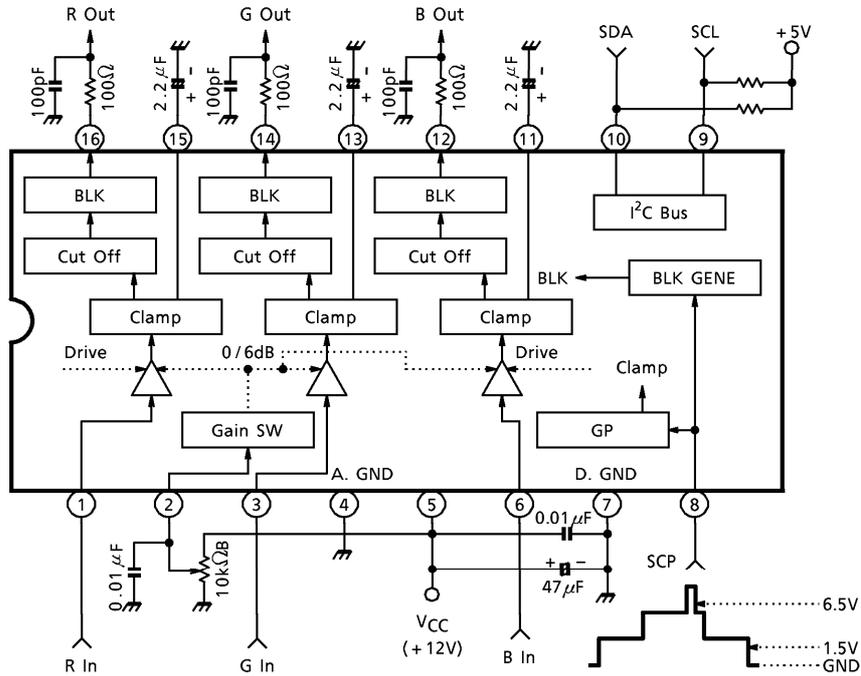


NOTE No.	ITEM		TERMINAL 2 MODE	SUB ADDRESS & DATA			MEASUREMENT METHOD
				(I)	(II)	(III)	
6	OUTPUT Dynamic Range	Max. DC	6dB (7.5V)	00H	02H	FFH	(1) Pin 8 : S.C.P. or Gate pulse. (2) Pin 1 (pin 6) : signal = (under Fig.) (3) Make input signal larger to output signal saturation level. Measure the output level. →GODA (4) Make input signal smaller to output signal saturation level. Measure the output level. →GODI 
		Min. DC					

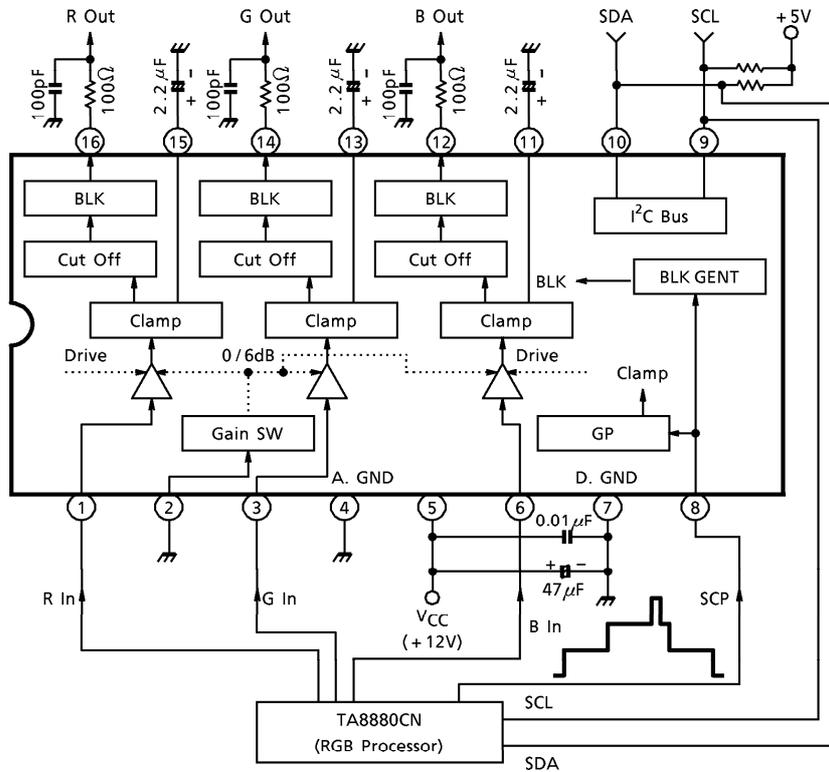
Cut off circuit

NOTE No.	ITEM		TERMINAL 2 MODE	SUB ADDRESS & DATA			MEASUREMENT METHOD
				(I)	(II)	(III)	
7	Min. Variable Range		0dB (GND)	00H ↓ 01H	00H	80H	(1) The same as Note 6. (2) Pin 1 (Pin 3, 6) : DC 2V. (3) Subaddress data (I) : 00H→01H. Measure the DC voltage gap of output DC level.
8	Control Range	Max.	↑	FFH	03H	↑	(1) The same as Note 6. (2) The same as Note 7. (3) SA (I) (II) : FF03H, 0000H ; Measure the output DC level of each DATA.
		Min.		00H	00H		
9	Center Off-set		↑	00H	02H	↑	(1) The same as Note 6. (2) The same as Note 7. (3) (Output DC level) – (Input DC level 2V)
10	Max. Input DC Level		↑	00H	00H	↑	(1) The same as Note 6. (2) SA (I) (II) : 0000H ; Increase input DC level to output DC saturation level, Measure the input DC level. →V _I MA (3) Decrease input DC level to output DC saturation level, Measure the output DC level. →V _O MI (4) SA (I) (II) : FF03H ; Decrease input DC level to output DC saturation level, Measure the input DC level. →V _I MI (5) Increase input DC level to output DC saturation level, Measure the output DC level. →V _O MA
	Min. Input DC Level		↑	FFH	03H	↑	
	Max. Output DC Level		↑	00H	03H	↑	
	Min. Output DC Level		↑	FFH	03H	↑	
11	Non Liner Point Value	SA : 7F00	↑	7F00H ↓ 8000H		↑	(1) The same as Note 6. (2) Pin 1 (Pin 3, 6) : DC 2V. (3) SA (I) (II) : 7F00H→8000H, FF00H→0001H, FF01H→0002H ; Measure the DC voltage gap of each point.
		SA : FF00		7F00H ↓ 8000H			
		SA : FF01		7F00H ↓ 8000H			
12	Blanking Level		0dB (GND)	00H	02H	↑	(1) Pin 8 : S.C.P. or Gate pulse. (2) Pin 1 (Pin 3, 6) : DC 2V. (3) Measure The BLANKING LEVEL.

TEST CIRCUIT

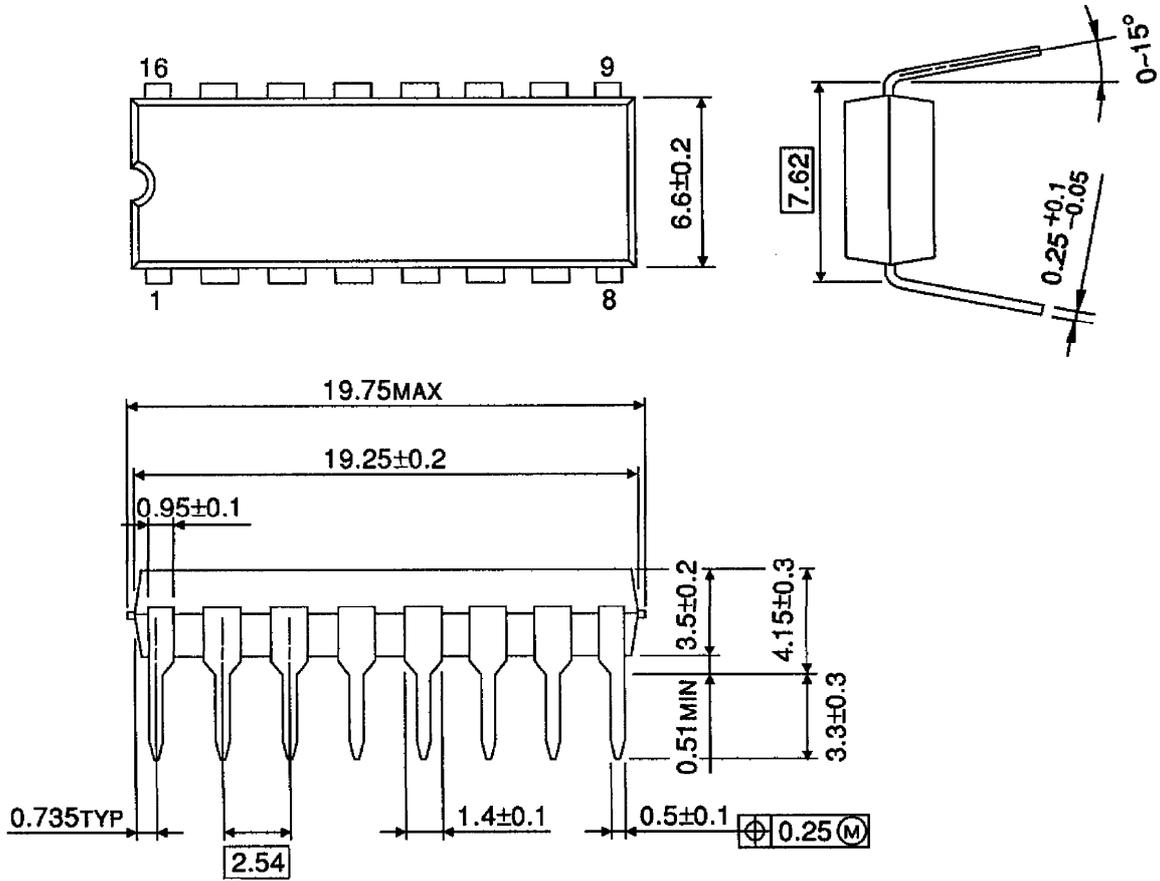


APPLICATION CIRCUIT



PACKAGE DIMENSIONS
DIP16-P-300-2.54B

Unit : mm



Weight : 1.11g (Typ.)

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000707EBA

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